

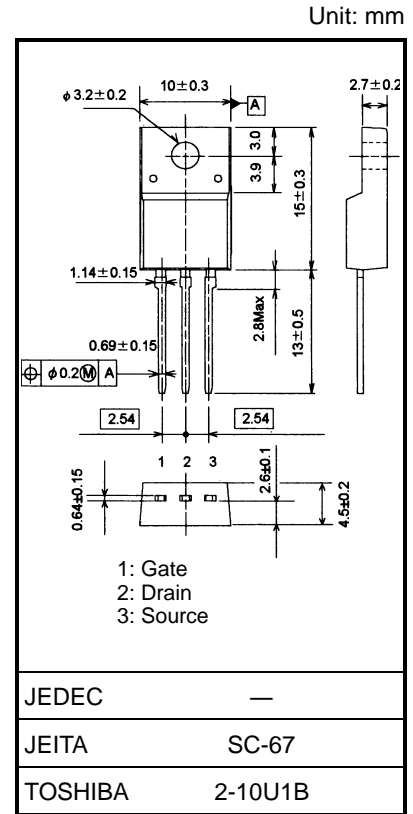
TK25A10K3

Switching Regulator Applications

- Low drain-source ON resistance: $R_{DS(ON)} = 31 \text{ m}\Omega$ (typ.)
- High forward transfer admittance: $|Y_{fs}| = 50 \text{ S}$ (typ.)
- Low leakage current: $I_{DSS} = 10 \text{ }\mu\text{A}$ (max) ($V_{DS} = 100 \text{ V}$)
- Enhancement-model: $V_{th} = 2.0 \text{ to } 4.0 \text{ V}$ ($V_{DS} = 10 \text{ V}$, $I_D = 1 \text{ mA}$)

Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	100	V
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V_{DGR}	100	V
Gate-source voltage		V_{GSS}	± 20	V
Drain current	DC (Note 1)	I_D	25	A
	Pulse (Note 1)	I_{DP}	50	
Drain power dissipation ($T_c = 25^\circ\text{C}$)		P_D	25	W
Single pulse avalanche energy (Note 2)		E_{AS}	39	mJ
Avalanche current		I_{AR}	25	A
Repetitive avalanche energy (Note 3)		E_{AR}	1.72	mJ
Channel temperature		T_{ch}	150	$^\circ\text{C}$
Storage temperature range		T_{stg}	-55 to 150	$^\circ\text{C}$



Weight: 1.7 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/“Derating Concept and Methods”) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

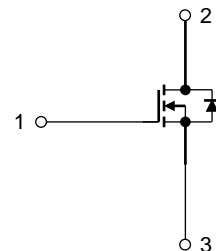
Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2: $V_{DD} = 25 \text{ V}$, $T_{ch} = 25^\circ\text{C}$ (initial), $L = 100 \text{ }\mu\text{H}$, $R_G = 25 \text{ }\Omega$, $I_{AR} = 25 \text{ A}$

Note 3: Repetitive rating; pulse width limited by maximum channel temperature.

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	$R_{th(ch-c)}$	5.0	$^\circ\text{C/W}$
Thermal resistance, channel to ambient	$R_{th(ch-a)}$	62.5	$^\circ\text{C/W}$



This transistor is an electrostatic sensitive device. Please handle with caution.

Start of commercial production
2009-06

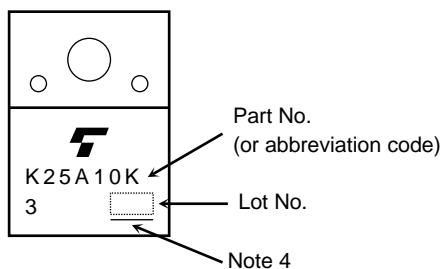
Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		IGSS	VGS = ±20 V, VDS = 0 V	—	—	±100	nA
Drain cut-OFF current		IDSS	VDS = 100 V, VGS = 0 V	—	—	10	μA
Drain-source breakdown voltage		V(BR)DSS	ID = 10 mA, VGS = 0 V	100	—	—	V
		V(BR)DSX	ID = 10 mA, VGS = -20 V	65	—	—	
Gate threshold voltage		Vth	VDS = 10 V, ID = 1 mA	2.0	—	4.0	V
Drain-source ON resistance		RDS(ON)	VGS = 10 V, ID = 12 A	—	31	40	mΩ
Forward transfer admittance		Yfs	VDS = 10 V, ID = 12 A	25	50	—	S
Input capacitance		Ciss	VDS = 10 V, VGS = 0 V, f = 1 MHz	—	1580	—	pF
Reverse transfer capacitance		Crss		—	135	—	
Output capacitance		Coss		—	200	—	
Switching time	Rise time	tr		—	13	—	ns
	Turn-on time	ton		—	25	—	
	Fall time	tf		—	8	—	
	Turn-off time	toff		—	37	—	
Total gate charge (gate-source plus gate-drain)		Qg	VDD ≈ 80 V, VGS = 10 V, ID = 25 A	—	34	—	nC
Gate-source charge		Qgs1		—	7	—	
Gate-drain ("miller") charge		Qgd		—	13	—	

Source-Drain Ratings and Characteristics (Ta = 25°C)

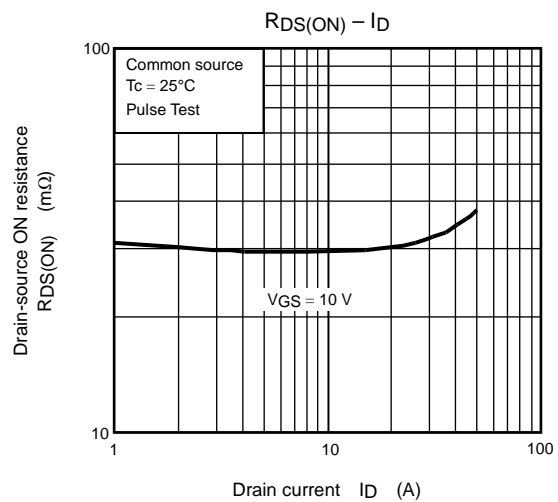
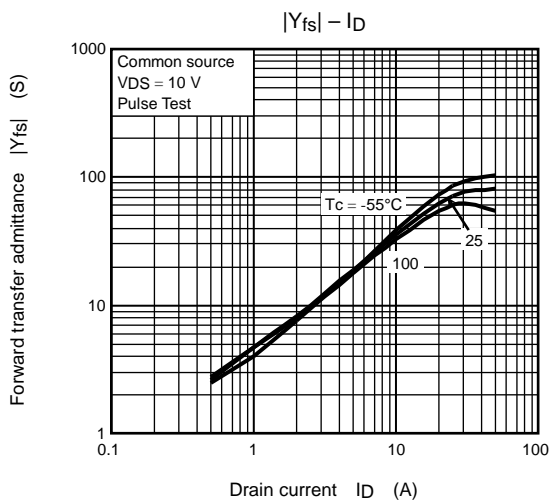
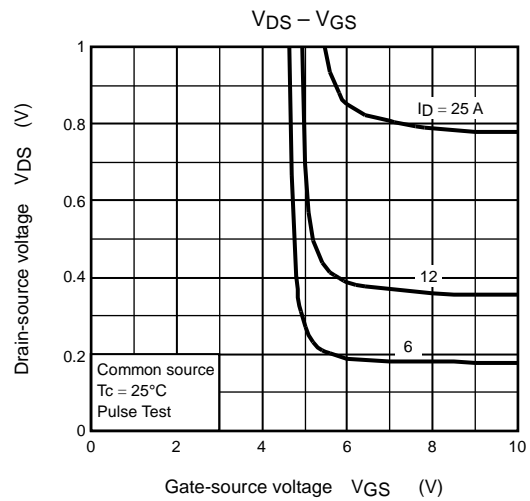
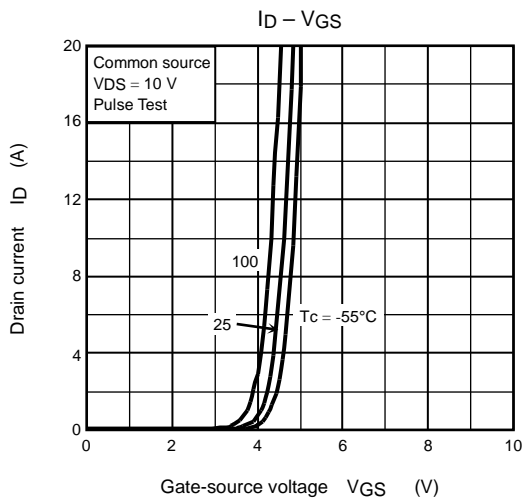
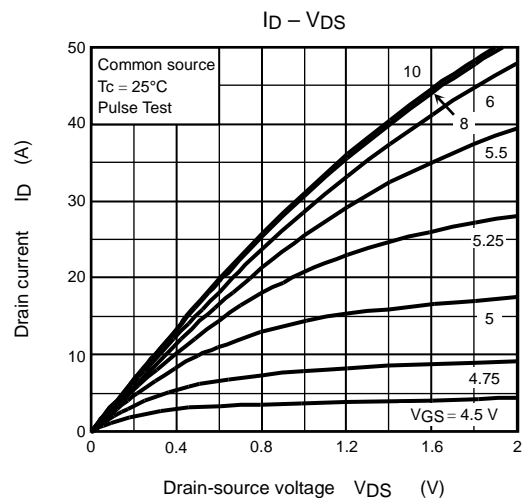
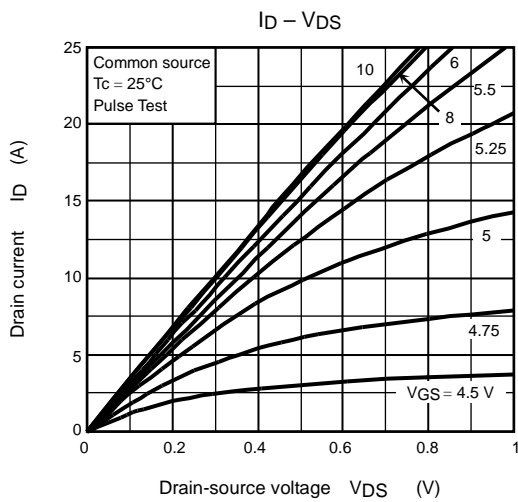
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Continuous drain reverse current (Note 1)	IDR	—	—	—	25	A
Pulse drain reverse current (Note 1)	IDRP	—	—	—	50	A
Forward voltage (diode)	VDSF	IDR = 25 A, VGS = 0 V	—	—	-1.4	V
Reverse recovery time	trr	IDR = 25 A, VGS = 0 V,	—	57	—	ns
Reverse recovery charge	Qrr	dIDR/dt = 50 A/μs	—	61	—	nC

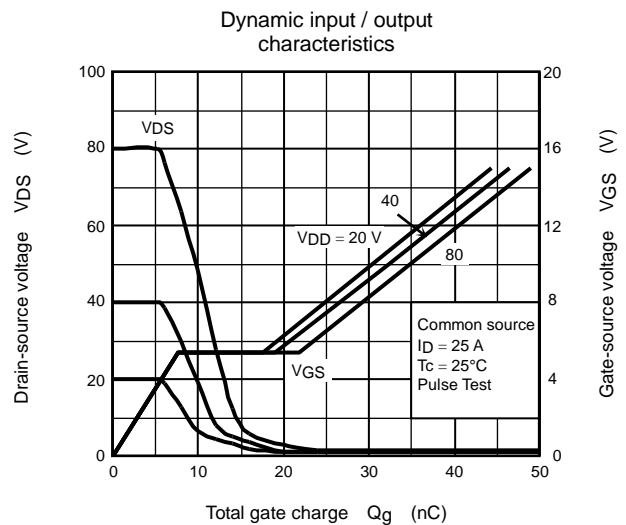
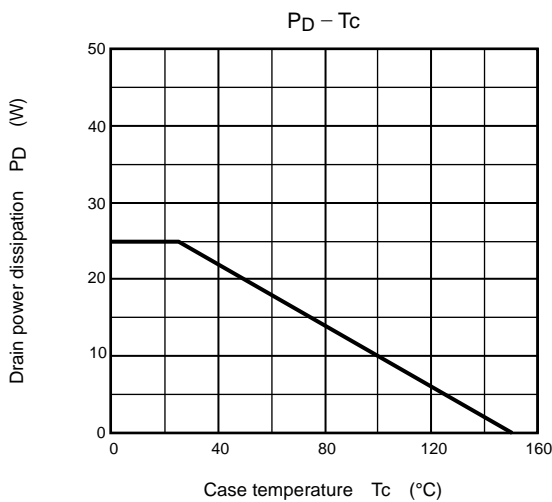
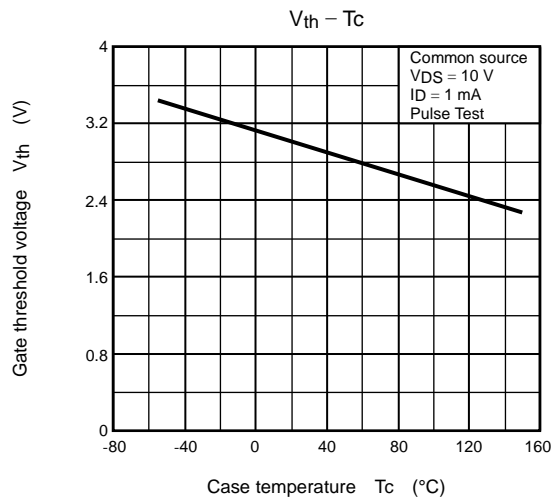
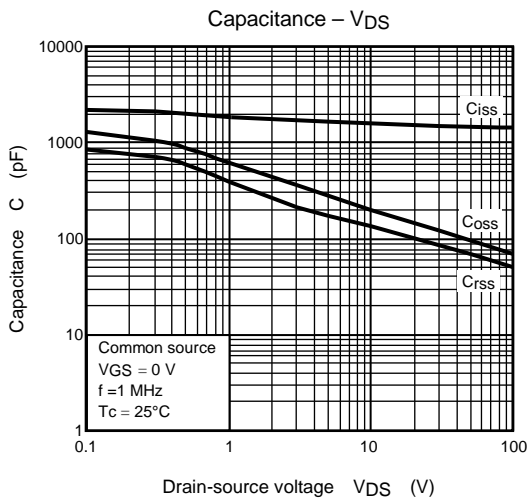
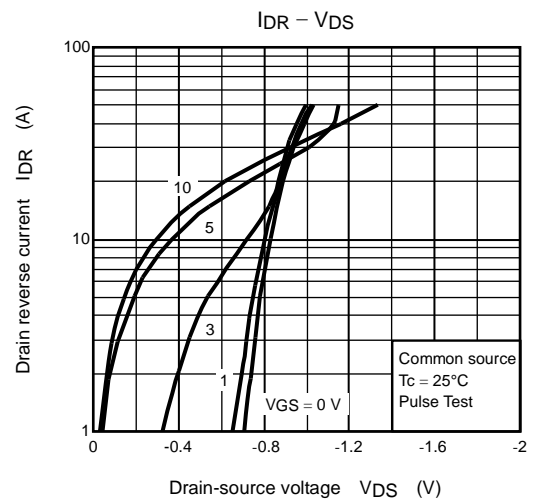
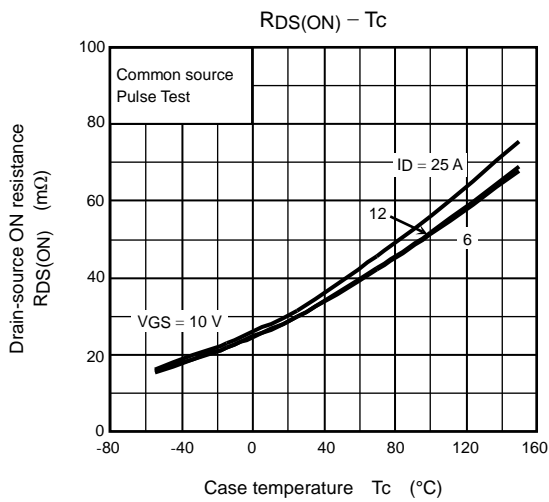
Marking

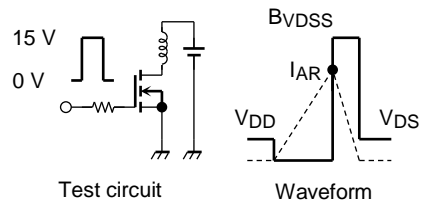
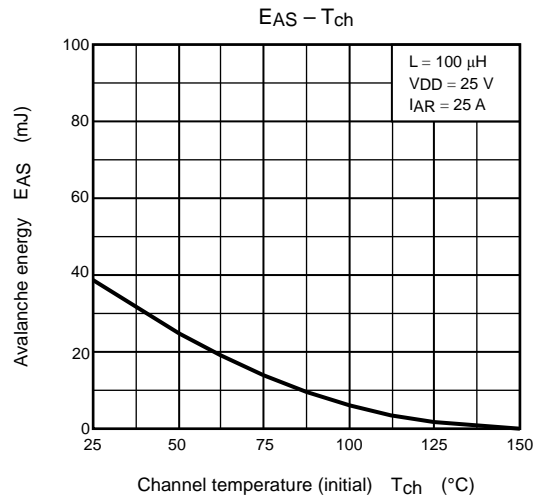
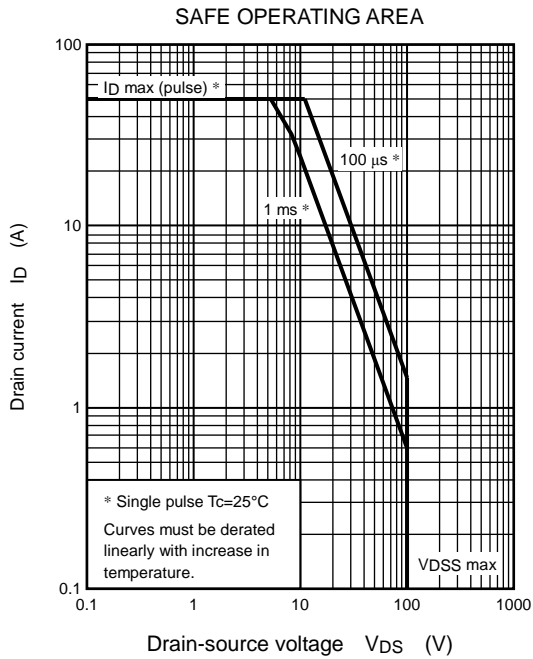
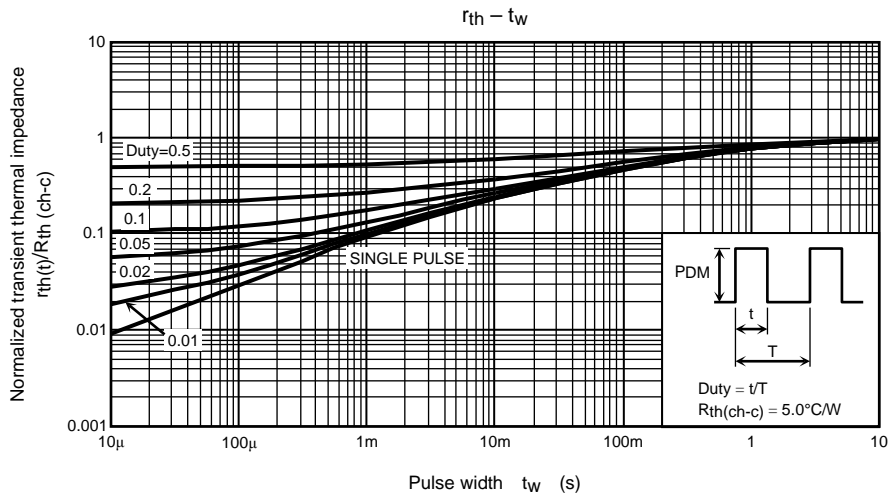


Note 4: A line under a Lot No. identifies the indication of product Labels
 Not underlined: [[Pb]]/INCLUDES > MCV
 Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment







$$R_G = 25 \Omega$$

$$V_{DD} = 25 \text{ V}, L = 100 \mu\text{H}$$

$$E_{AS} = \frac{1}{2} \cdot L \cdot I_{AR}^2 \cdot \left(\frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$$

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